



A Product Line of Diodes Incorporated

DMC4028SSD

40V COMPLEMENTARY DUAL ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(on)} Max	I _D T _A = +25°C	
Q1	40V	28mΩ @ V _{GS} = 10V	7.2A	
QT	40 V	40 V	49mΩ @ V _{GS} = 4.5V	5.4A
Q2	-40V	50mΩ @ V _{GS} = -10V	-5.2A	
QZ	-40 V	79mΩ @ V _{GS} = -4.5V	-4.7A	

Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

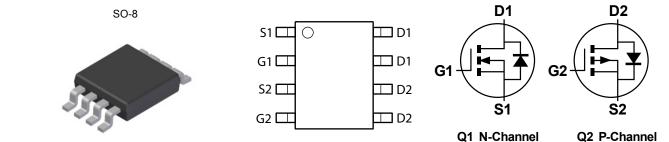
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

Features and Benefits

- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (approximate)



Top View

Equivalent Circuit

Ordering Information (Note 4)

Top View

Part Number	Compliance	Case	Packaging
DMC4028SSD-13	Standard	SO-8	2500 / Tape & Reel
DMC4028SSDQ-13	Automotive	SO-8	2500 / Tape & Reel

Notes:

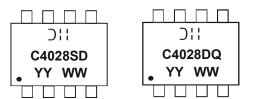
No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



>:! = Manufacturer's Marking C4028SD = Product Type Marking Code for DMC4028SSD-13 C4028DQ = Product Type Marking Code for DMC4028SSDQ-13 YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	N-Channel - Q1	P-Channel - Q2	Units
Drain-Source Voltage		V _{DSS}	40	-40	V	
Gate-Source Voltage		(Note 5)	V _{GSS}	±20	±20	V
Continuous Drain Current V _{GS} = 10V	(Notes 7 & 9)		7.2	5.2		
	V _{GS} = 10V	T _A = 70°C (Notes 7 & 9)	ID	5.5	4.2	А
		(Notes 6 & 9)		5.4	4	
		(Notes 6 & 10)		6.5	4.8	
Pulsed Drain Current	V _{GS} = 10V	(Notes 7 & 9)	I _{DM}	27.3	20.4	А
Continuous Source Current	(Body diode)	(Notes 7 & 9)	ls	3.35	3.15	А
Pulsed Source Current (Bod	y diode)	(Notes 8 & 9)	I _{SM}	27.3	20.4	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	N-Channel - Q1	P-Channel - Q2	Unit	
Dewes Discipation	(Notes 6 & 9)		1. 1	W mW/°C	
Power Dissipation Linear Derating Factor	(Notes 6 & 10)	PD	1 14		
	(Notes 7 & 9)		2. 17		
	(Notes 6 & 9)		1(°C/W	
Thermal Resistance, Junction to Ambient	(Notes 6 & 10)	R _{0JA}	70		
	(Notes 7 & 9)		58		
Thermal Resistance, Junction to Lead	(Notes 9 & 11)	R _{θJL}	53	53	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to	+150	°C

Notes: 5. AEC-Q101 V_{GS} maximum is \pm 16V.

6. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition. 7. Same as note (5), except the device is measured at t \leq 10 sec. 8. Same as note (5), except the device is pulsed with D= 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.

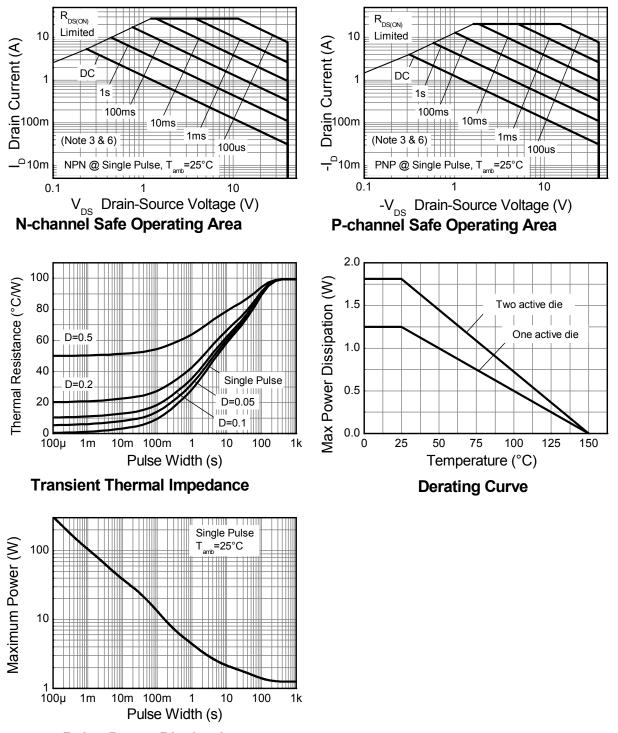
9. For a dual device with one active die.

10. For a device with two active die running at equal power.

11. Thermal resistance from junction to solder-point (at the end of the drain lead).



Thermal Characteristics



Pulse Power Dissipation



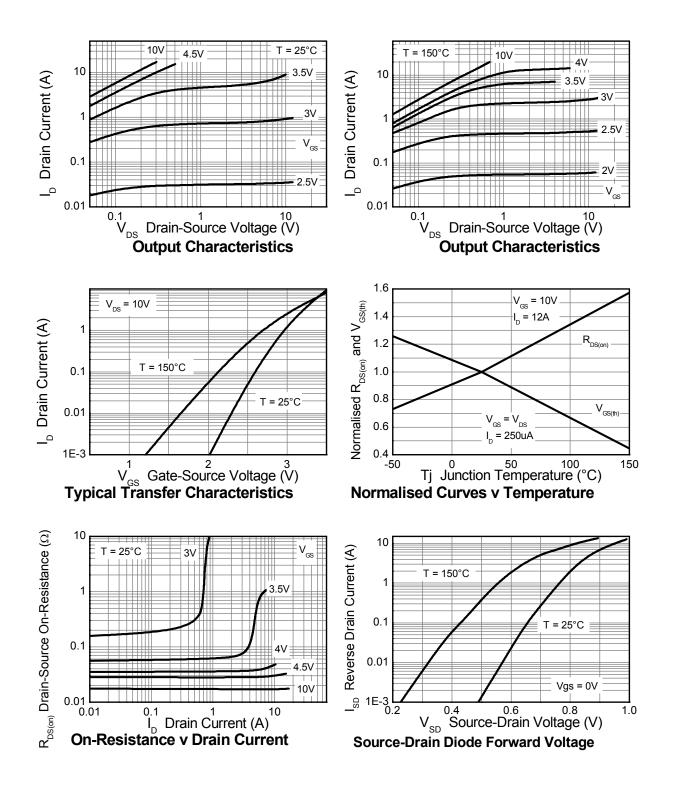
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	40	—	_	V	I _D = 250µA, V _{GS} = 0V		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μA	V _{DS} = 40V, V _{GS} = 0V		
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V_{GS} = ±20V, V_{DS} = 0V		
ON CHARACTERISTICS			÷					
Gate Threshold Voltage	V _{GS(th)}	1.0	_	3.0	V	I _D = 250μA, V _D	s = V _{GS}	
Static Drain-Source On-Resistance (Note 12)	Pro (o)		0.018	0.028	Ω	V _{GS} = 10V, I _D = 6A		
	R _{DS (ON)}		0.033	0.049	12	V _{GS} = 4.5V, I _D	= 5A	
Forward Transconductance (Notes 12 & 13)	g fs	_	22.8	_	S	V _{DS} = 15V, I _D = 6A		
Diode Forward Voltage (Note 12)	V _{SD}		0.845	1.1	V	I _S = 6A, V _{GS} = 0V		
Reverse recovery time (Note 13)	t _{rr}		135	_	ns	$L_{1} = 6A_{1} di/dt = 100A/o$		
Reverse recovery charge (Note 13)	Qrr	_	799	_	nC	$I_{\rm S}$ = 6A, di/dt = 100A/µs		
DYNAMIC CHARACTERISTICS (Note 13)	<u> </u>		·	•		·		
Input Capacitance	C _{iss}	_	604		pF	$V_{DS} = 20V, V_{GS} = 0V$		
Output Capacitance	C _{oss}	_	106	_	pF			
Reverse Transfer Capacitance	C _{rss}	_	59.6	_	pF			
Total Gate Charge (Note 14)	Qg	_	6.5		nC	V _{GS} = 4.5V		
Total Gate Charge (Note 14)	Qg	_	12.9		nC		V _{DS} = 20V	
Gate-Source Charge (Note 14)	Qgs	_	2.3		nC	V _{GS} = 10V	I _D = 6A	
Gate-Drain Charge (Note 14)	Q _{gd}	_	3.6	_	nC			
Turn-On Delay Time (Note 14)	t _{D(on)}	_	4.2		ns			
Turn-On Rise Time (Note 14)	tr	_	12.4		ns	V _{DD} = 20V, V _{GS} = 10V		
Turn-Off Delay Time (Note 14)	t _{D(off)}	_	13.8	_	ns	$I_D = 6A, R_G \cong 6$.0Ω	
Turn-Off Fall Time (Note 14)	t _f	_	10.7	_	ns			

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12. Measured under pulsed conditions. Pulse width \leq 300 μ s; duty cycle \leq 2% 13. For design aid only, not subject to production testing. 14. Switching characteristics are independent of operating junction temperatures. Notes:

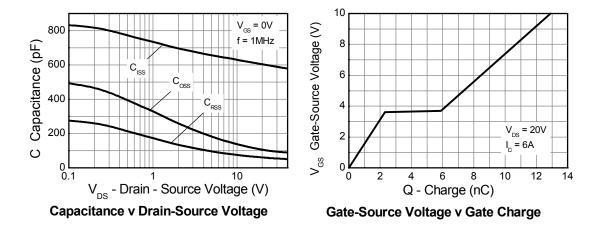


Typical Characteristics – Q1 N-Channel

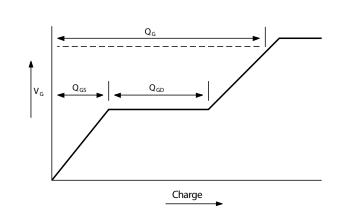




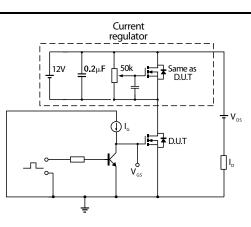
Typical Characteristics – Q1 N-Channel - (cont.)



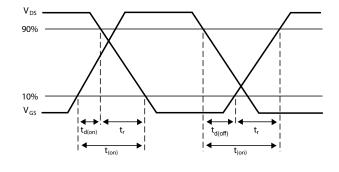
Test Circuits – Q1 N-Channel



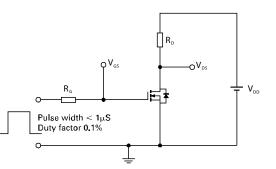




Gate charge test circuit



Switching time waveforms



Switching time test circuit



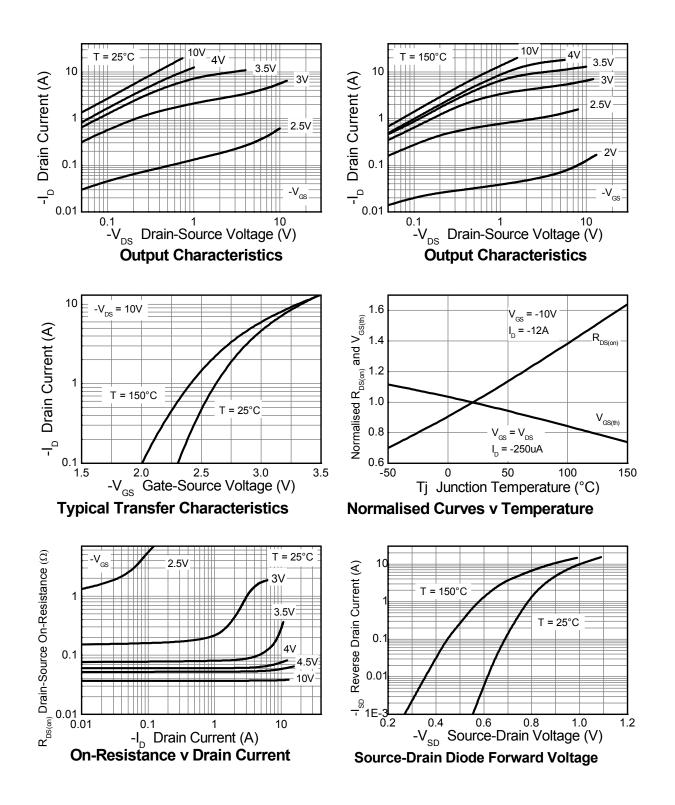
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	-40	_	—	V	I _D = -250 μA, V _{GS} = 0V		
Zero Gate Voltage Drain Current	I _{DSS}	_	—	-0.5	μA	V _{DS} = -40V, V _{GS} = 0V		
Gate-Source Leakage	I _{GSS}	_	—	±100	nA	V_{GS} = ±20V, V_{DS} = 0V		
ON CHARACTERISTICS								
Gate Threshold Voltage	V _{GS(th)}	-1.0	-	-3.0	V	I _D = -250 μA, V	_{DS} = V _{GS}	
Statia Drain Source On Desistance (Note 12)	D		0.039	0.050	Ω	V _{GS} = -10V, I _D = -6A V _{GS} = -4.5V, I _D = -5A		
Static Drain-Source On-Resistance (Note 12)	R _{DS(ON)}	_	0.060	0.079	Ω			
Forward Transconductance (Notes 12 & 13)	g fs	_	16.6	—	S	V _{DS} = -15V, I _D = -6A		
Diode Forward Voltage (Note 13)	V _{SD}	_	-0.865	-1.1	V	I _S = -6A, V _{GS} = 0V		
Reverse Recovery Time (Note 13)	t _{rr}	_	138	_	ns			
Reverse Recovery Charge (Note 13)	Q _{rr}	_	841	_	nC	I _S = -6A, di/dt = 100A/μs		
DYNAMIC CHARACTERISTICS (Note 13)								
Input Capacitance	C _{iss}	—	674	_	pF	V _{DS} = -20V, V _{GS} = 0V f = 1MHz		
Output Capacitance	C _{oss}	—	115	—	pF			
Reverse Transfer Capacitance	C _{rss}	_	67.7	—	pF			
Total Gate Charge (Note 14)	Qg	_	7.0	—	nC	V _{GS} = -4.5V		
Total Gate Charge (Note 14)	Qg	_	14	—	nC	$V_{\rm GS} = -10V$ $V_{\rm DS} = -20V$ $V_{\rm DS} = -6A$		
Gate-Source Charge (Note 14)	Q _{gs}	_	2.2	—	nC			
Gate-Drain Charge (Note 14)	Q _{gd}	_	3.7	—	nC			
Turn-On Delay Time (Note 14)	t _{D(on)}	_	2.3	—	ns			
Turn-On Rise Time (Note 14)	tr	_	14.1	—	ns	V _{DD} = -20V, V _G	_S = -10V	
Turn-Off Delay Time (Note 14)	t _{D(off)}	_	25.1	—	ns	$I_D = -6A, R_G \cong 6$	δ.0Ω	
Turn-Off Fall Time (Note 14)	t _f	_	14.3	—	ns	7		

Electrical Characteristics O2 P Channel

12. Measured under pulsed conditions. Pulse width \leq 300µs; duty cycle \leq 2% 13. For design aid only, not subject to production testing. 14. Switching characteristics are independent of operating junction temperatures. Notes:

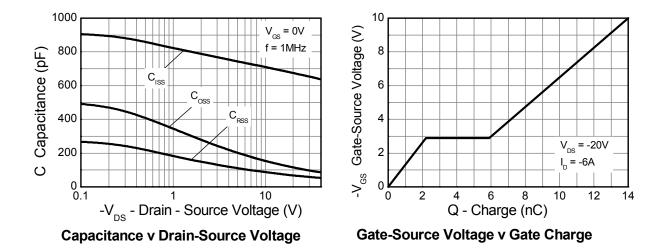


Typical Characteristics – Q2 P-Channel

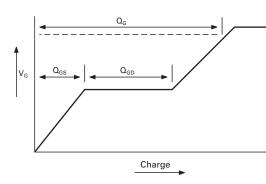




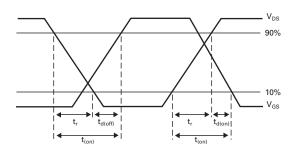
Typical Characteristics – Q2 P-Channel – (cont.)



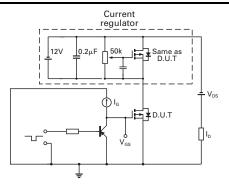
Test Circuits – Q2 P-Channel



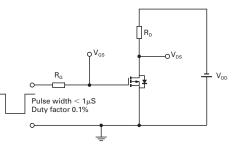
Basic gate charge waveform



Switching time waveforms



Gate charge test circuit

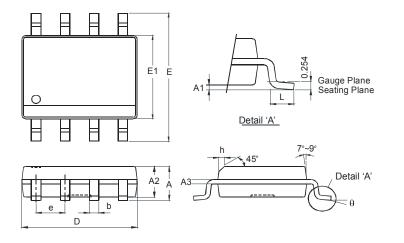


Switching time test circuit



Package Outline Dimensions

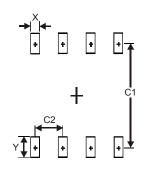
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SO-8						
Dim	Min	Max					
Α	-	1.75					
A1	0.10	0.20					
A2	1.30	1.50					
A3	0.15	0.25					
b	0.3	0.5					
D	4.85	4.95					
ш	5.90	6.10					
E1	3.85	3.95					
e	1.27	Тур					
h	-	0.35					
L	0.62	0.82					
θ	0°	8°					
All Di	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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